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## HM51W17800B Series

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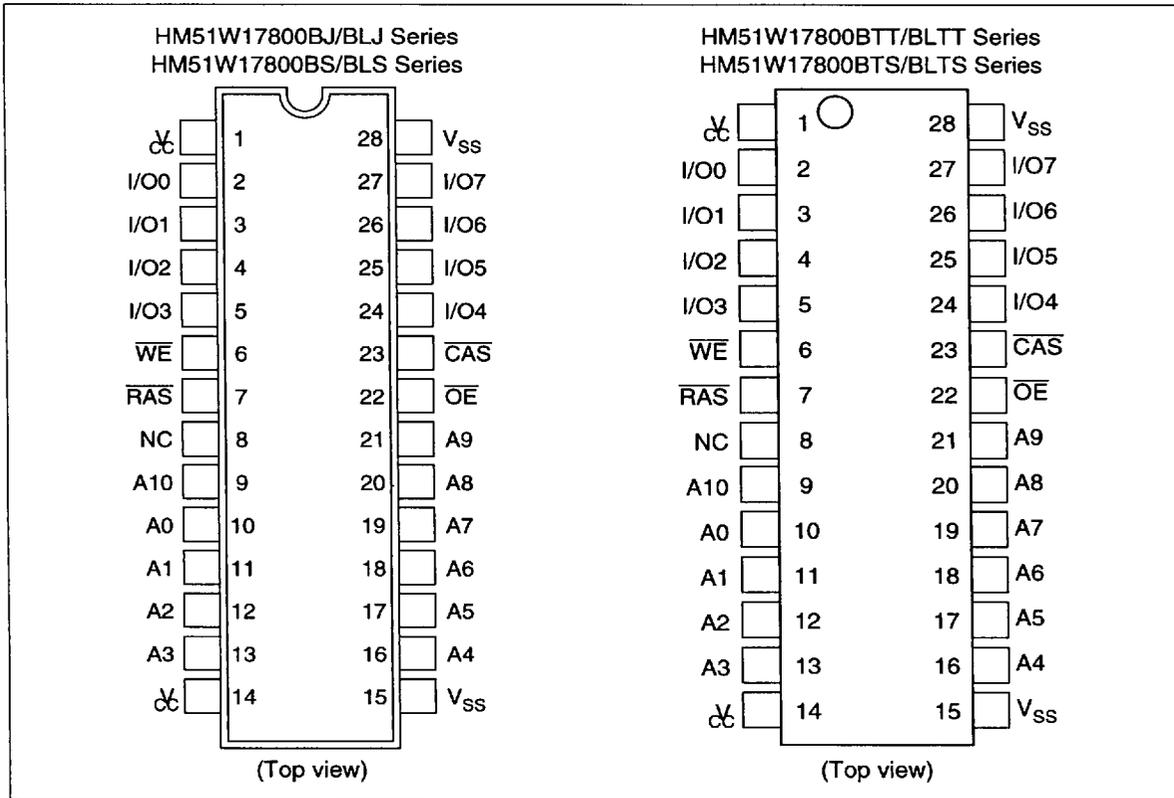
### Ordering Information

Type No.	Access time	Package
HM51W17800BJ-6	60 ns	400-mil 28-pin plastic SOJ (CP-28DA)
HM51W17800BJ-7	70 ns	
HM51W17800BJ-8	80 ns	
HM51W17800BLJ-6	60 ns	
HM51W17800BLJ-7	70 ns	
HM51W17800BLJ-8	80 ns	
HM51W17800BS-6* <sup>1</sup>	60 ns	300-mil 28-pin plastic SOJ (CP-28DNA)
HM51W17800BS-7* <sup>1</sup>	70 ns	
HM51W17800BS-8* <sup>1</sup>	80 ns	
HM51W17800BLS-6* <sup>1</sup>	60 ns	
HM51W17800BLS-7* <sup>1</sup>	70 ns	
HM51W17800BLS-8* <sup>1</sup>	80 ns	
HM51W17800BTT-6	60 ns	400-mil 28-pin plastic TSOP II (TTP-28DA)
HM51W17800BTT-7	70 ns	
HM51W17800BTT-8	80 ns	
HM51W17800BLTT-6	60 ns	
HM51W17800BLTT-7	70 ns	
HM51W17800BLTT-8	80 ns	
HM51W17800BTS-6* <sup>1</sup>	60 ns	300-mil 28-pin plastic TSOP II (TTP-28DB)
HM51W17800BTS-7* <sup>1</sup>	70 ns	
HM51W17800BTS-8* <sup>1</sup>	80 ns	
HM51W17800BLTS-6* <sup>1</sup>	60 ns	
HM51W17800BLTS-7* <sup>1</sup>	70 ns	
HM51W17800BLTS-8* <sup>1</sup>	80 ns	

Note: 1. Under development

# HM51W17800B Series

## Pin Arrangement



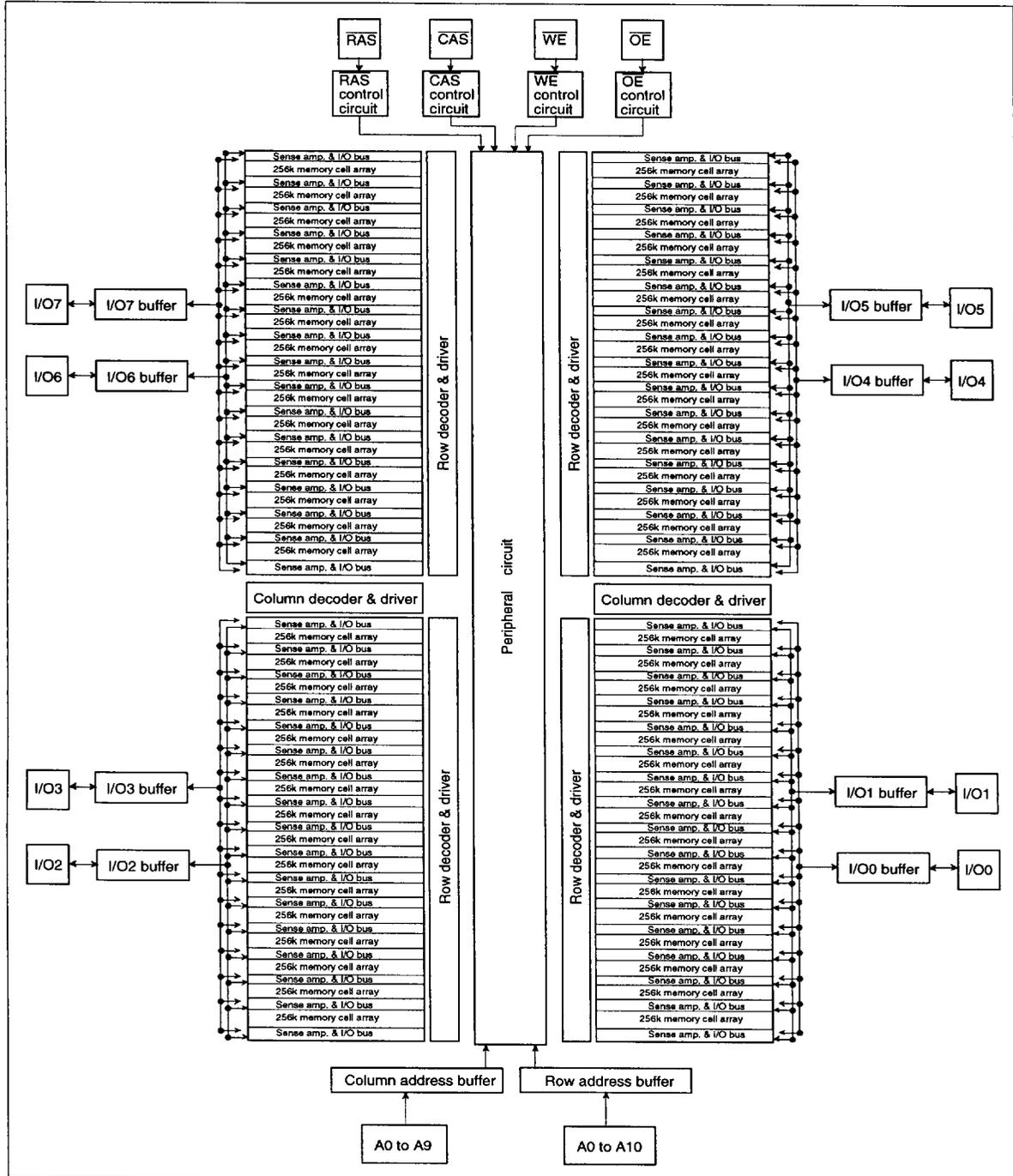
## Pin Description

Pin name	Function
A0 to A10	Address input <ul style="list-style-type: none"> <li>• Row/Refresh address A0 to A10</li> <li>• Column address A0 to A9</li> </ul>
I/O0 to I/O7	Data input/data output
$\overline{\text{RAS}}$	Row address strobe
$\overline{\text{CAS}}$	Column address strobe
$\overline{\text{WE}}$	Read/Write enable
$\overline{\text{OE}}$	Output enable
$V_{\text{CC}}$	Power supply
$V_{\text{SS}}$	Ground
NC	No connection

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# HM51W17800B Series

## Block Diagram



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**HM51W17800B Series**

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**Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit
Voltage on any pin relative to $V_{SS}$	$V_T$	-0.5 to + 4.6	V
Supply voltage relative to $V_{SS}$	$V_{CC}$	-0.5 to + 4.6	V
Short circuit output current	$I_{out}$	50	mA
Power dissipation	$P_T$	1.0	W
Operating temperature	$T_{opr}$	0 to +70	°C
Storage temperature	$T_{stg}$	-55 to +125	°C

**Recommended DC Operating Conditions ( $T_a = 0$  to +70°C)**

Parameter	Symbol	Min	Typ	Max	Unit	Notes
Supply voltage	$V_{CC}$	3.0	3.3	3.6	V	1, 2
Input high voltage	$V_{IH}$	2.0	—	$V_{CC} + 0.3$	V	1
Input low voltage	$V_{IL}$	-0.3	—	0.8	V	1

Notes: 1. All voltage referred to  $V_{SS}$

## HM51W17800B Series

DC Characteristics ( $T_a = 0$  to  $+70^\circ\text{C}$ ,  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ )

Parameter	Symbol	HM51W17800B						Unit	Test conditions
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Operating current <sup>1,2</sup>	$I_{CC1}$	—	120	—	110	—	100	mA	$t_{RC} = \text{min}$
Standby current	$I_{CC2}$	—	2	—	2	—	2	mA	TTL interface $\overline{\text{RAS}}, \overline{\text{CAS}} = V_{IH}$ Dout = High-Z
		—	1	—	1	—	1	mA	CMOS interface $\overline{\text{RAS}}, \overline{\text{CAS}} \geq V_{CC} - 0.2\text{V}$ Dout = High-Z
Standby current (L-version)	$I_{CC2}$	—	150	—	150	—	150	$\mu\text{A}$	CMOS interface $\overline{\text{RAS}}, \overline{\text{CAS}} \geq V_{CC} - 0.2\text{V}$ Dout = High-Z
$\overline{\text{RAS}}$ -only refresh current <sup>2</sup>	$I_{CC3}$	—	120	—	110	—	100	mA	$t_{RC} = \text{min}$
Standby current <sup>1</sup>	$I_{CC5}$	—	5	—	5	—	5	mA	$\overline{\text{RAS}} = V_{IH}$ $\overline{\text{CAS}} = V_{IL}$ Dout = enable
CAS-before-RAS refresh current	$I_{CC6}$	—	120	—	110	—	100	mA	$t_{RC} = \text{min}$
Fast page mode current <sup>1,3</sup>	$I_{CC7}$	—	100	—	90	—	85	mA	$t_{PC} = \text{min}$
Battery backup current <sup>4</sup> (Standby with CBR refresh) (L-version)	$I_{CC10}$	—	400	—	400	—	400	$\mu\text{A}$	CMOS interface Dout = High-Z CBR refresh: $t_{RC} = 62.5 \mu\text{s}$ $t_{RAS} \leq 0.3 \mu\text{s}$
Self refresh mode current (L-version)	$I_{CC11}$	—	250	—	250	—	250	$\mu\text{A}$	CMOS interface $\overline{\text{RAS}}, \overline{\text{CAS}} \leq 0.2\text{V}$ Dout = High-Z
Input leakage current	$I_{LI}$	-10	10	-10	10	-10	10	$\mu\text{A}$	$0 \text{ V} \leq V_{in} \leq 4.6 \text{ V}$
Output leakage current	$I_{LO}$	-10	10	-10	10	-10	10	$\mu\text{A}$	$0 \text{ V} \leq V_{out} \leq 4.6 \text{ V}$ Dout = disable
Output high voltage	$V_{OH}$	2.4	$V_{CC}$	2.4	$V_{CC}$	2.4	$V_{CC}$	V	High Iout = -2 mA
Output low voltage	$V_{OL}$	0	0.4	0	0.4	0	0.4	V	Low Iout = 2 mA

Notes: 1.  $I_{CC}$  depends on output load condition when the device is selected.  $I_{CC}$  max is specified at the output open condition.

2. Address can be changed once or less while  $\overline{\text{RAS}} = V_{IL}$ .

3. Address can be changed once or less while  $\overline{\text{CAS}} = V_{IH}$ .

4.  $\overline{\text{CAS}} = L$  ( $\leq 0.2 \text{ V}$ ) while  $\overline{\text{RAS}} = L$  ( $\leq 0.2 \text{ V}$ ).

## HM51W17800B Series

### Capacitance (Ta = 25°C, V<sub>CC</sub> = 3.3 V ± 0.3 V)

Parameter	Symbol	Typ	Max	Unit	Notes
Input capacitance (Address)	C <sub>I1</sub>	—	5	pF	1
Input capacitance (Clocks)	C <sub>I2</sub>	—	7	pF	1
Output capacitance (Data-in, Data-out)	C <sub>IO</sub>	—	7	pF	1, 2

Notes: 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.  
 2.  $\overline{\text{CAS}} = V_{\text{IH}}$  to disable Dout.

### AC Characteristics (Ta = 0 to +70°C, V<sub>CC</sub> = 3.3 V ± 0.3 V, V<sub>SS</sub> = 0 V)<sup>\*1, \*2, \*18</sup>

#### Test Conditions

- Input rise and fall time: 5 ns
- Input timing reference levels: 0.8 V, 2.0 V
- Output timing reference levels: 0.8 V, 2.0 V
- Output load: 1 TTL gate + C<sub>L</sub> (100 pF) (Including scope and jig)

#### Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters)

Parameter	Symbol	HM51W17800B						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Random read or write cycle time	t <sub>RC</sub>	110	—	130	—	150	—	ns	
RAS precharge time	t <sub>RP</sub>	40	—	50	—	60	—	ns	
CAS precharge time	t <sub>CP</sub>	10	—	10	—	10	—	ns	
RAS pulse width	t <sub>RAS</sub>	60	10000	70	10000	80	10000	ns	
CAS pulse width	t <sub>CAS</sub>	15	10000	18	10000	20	10000	ns	
Row address setup time	t <sub>ASR</sub>	0	—	0	—	0	—	ns	
Row address hold time	t <sub>RAH</sub>	10	—	10	—	10	—	ns	
Column address setup time	t <sub>ASC</sub>	0	—	0	—	0	—	ns	
Column address hold time	t <sub>CAH</sub>	10	—	15	—	15	—	ns	
RAS to CAS delay time	t <sub>RCD</sub>	20	45	20	52	20	60	ns	3
RAS to column address delay time	t <sub>RAD</sub>	15	30	15	35	15	40	ns	4
RAS hold time	t <sub>RSH</sub>	15	—	18	—	20	—	ns	
CAS hold time	t <sub>CSH</sub>	60	—	70	—	80	—	ns	
CAS to RAS precharge time	t <sub>CRP</sub>	5	—	5	—	5	—	ns	
OE to Din delay time	t <sub>OED</sub>	15	—	18	—	20	—	ns	5
OE delay time from Din	t <sub>DZO</sub>	0	—	0	—	0	—	ns	6
CAS delay time from Din	t <sub>DZC</sub>	0	—	0	—	0	—	ns	6
Transition time (rise and fall)	t <sub>T</sub>	3	50	3	50	3	50	ns	7

## HM51W17800B Series

### Read Cycle

Parameter	Symbol	HM51W17800B						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Access time from $\overline{\text{RAS}}$	$t_{\text{RAC}}$	—	60	—	70	—	80	ns	8, 9
Access time from $\overline{\text{CAS}}$	$t_{\text{CAC}}$	—	15	—	18	—	20	ns	9, 10, 17
Access time from address	$t_{\text{AA}}$	—	30	—	35	—	40	ns	9, 11, 17
Access time from $\overline{\text{OE}}$	$t_{\text{OEA}}$	—	15	—	18	—	20	ns	9
Read command setup time	$t_{\text{RCS}}$	0	—	0	—	0	—	ns	
Read command hold time to $\overline{\text{CAS}}$	$t_{\text{RCH}}$	0	—	0	—	0	—	ns	12
Read command hold time to $\overline{\text{RAS}}$	$t_{\text{RRH}}$	0	—	0	—	0	—	ns	12
Column address to $\overline{\text{RAS}}$ lead time	$t_{\text{RAL}}$	30	—	35	—	40	—	ns	
Column address to $\overline{\text{CAS}}$ lead time	$t_{\text{CAL}}$	30	—	35	—	40	—	ns	
$\overline{\text{CAS}}$ to output in low-Z	$t_{\text{CLZ}}$	0	—	0	—	0	—	ns	
Output data hold time	$t_{\text{OH}}$	3	—	3	—	3	—	ns	
Output data hold time from $\overline{\text{OE}}$	$t_{\text{OHO}}$	3	—	3	—	3	—	ns	
Output buffer turn-off time	$t_{\text{OFF}}$	—	15	—	15	—	15	ns	13
Output buffer turn-off to $\overline{\text{OE}}$	$t_{\text{OEZ}}$	—	15	—	15	—	15	ns	13
$\overline{\text{CAS}}$ to Din delay time	$t_{\text{CDD}}$	15	—	18	—	20	—	ns	5

### Write Cycle

Parameter	Symbol	HM51W17800B						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Write command setup time	$t_{\text{WCS}}$	0	—	0	—	0	—	ns	14
Write command hold time	$t_{\text{WCH}}$	10	—	15	—	15	—	ns	
Write command pulse width	$t_{\text{WP}}$	10	—	10	—	10	—	ns	
Write command to $\overline{\text{RAS}}$ lead time	$t_{\text{RWL}}$	15	—	18	—	20	—	ns	
Write command to $\overline{\text{CAS}}$ lead time	$t_{\text{CWL}}$	15	—	18	—	20	—	ns	
Data-in setup time	$t_{\text{DS}}$	0	—	0	—	0	—	ns	15
Data-in hold time	$t_{\text{DH}}$	10	—	15	—	15	—	ns	15

## HM51W17800B Series

### Read-Modify-Write Cycle

Parameter	Symbol	HM51W17800B						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Read-modify-write cycle time	$t_{RWC}$	155	—	181	—	205	—	ns	
RAS to WE delay time	$t_{RWD}$	85	—	98	—	110	—	ns	14
CAS to WE delay time	$t_{CWD}$	40	—	46	—	50	—	ns	14
Column address to WE delay time	$t_{AWD}$	55	—	63	—	70	—	ns	14
OE hold time from WE	$t_{OEH}$	15	—	18	—	20	—	ns	

### Refresh Cycle

Parameter	Symbol	HM51W17800B						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
CAS setup time (CBR refresh cycle)	$t_{CSR}$	5	—	5	—	5	—	ns	
CAS hold time (CBR refresh cycle)	$t_{CHR}$	10	—	10	—	10	—	ns	
WE setup time (CBR refresh cycle)	$t_{WRP}$	0	—	0	—	0	—	ns	
WE hold time (CBR refresh cycle)	$t_{WRH}$	10	—	10	—	10	—	ns	
RAS precharge to CAS hold time	$t_{RPC}$	0	—	0	—	0	—	ns	

### Fast Page Mode Cycle

Parameter	Symbol	HM51W17800B						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Fast page mode cycle time	$t_{PC}$	40	—	45	—	50	—	ns	
Fast page mode RAS pulse width	$t_{RASP}$	—	100000	—	100000	—	100000	ns	16
Access time from CAS precharge	$t_{CPA}$	—	35	—	40	—	45	ns	9, 17
RAS hold time from CAS precharge	$t_{CPRH}$	35	—	40	—	45	—	ns	

### Fast Page Mode Read-Modify-Write Cycle

Parameter	Symbol	HM51W17800B						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Fast page mode read- modify-write cycle time	$t_{PRWC}$	85	—	96	—	105	—	ns	
WE delay time from CAS precharge	$t_{CPW}$	60	—	68	—	75	—	ns	14

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## HM51W17800B Series

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### Refresh

Parameter	Symbol	Max	Unit	Note
Refresh period	$t_{REF}$	32	ms	2048 cycles
Refresh period (L-version)	$t_{REF}$	128	ms	2048 cycles

## HM51W17800B Series

### Self Refresh Mode (L-version)

Parameter	Symbol	HM51W17800BL						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
$\overline{\text{RAS}}$ pulse width (self refresh)	$t_{\text{RASS}}$	100	—	100	—	100	—	$\mu\text{s}$	
$\overline{\text{RAS}}$ precharge time (self refresh)	$t_{\text{RPS}}$	110	—	130	—	150	—	ns	
$\overline{\text{CAS}}$ hold time (self refresh)	$t_{\text{CHS}}$	-50	—	-50	—	-50	—	ns	

- Notes:
- AC measurements assume  $t_t = 5 \text{ ns}$ .
  - An initial pause of  $200 \mu\text{s}$  is required after power up followed by a minimum of eight initialization cycles (any combination of cycles containing  $\overline{\text{RAS}}$ -only refresh or  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  refresh). If the internal refresh counter is used, a minimum of eight  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  refresh cycles are required.
  - Operation with the  $t_{\text{RCD}}$  (max) limit insures that  $t_{\text{RAC}}$  (max) can be met,  $t_{\text{RCD}}$  (max) is specified as a reference point only; if  $t_{\text{RCD}}$  is greater than the specified  $t_{\text{RCD}}$  (max) limit, then access time is controlled exclusively by  $t_{\text{CAC}}$ .
  - Operation with the  $t_{\text{RAD}}$  (max) limit insures that  $t_{\text{RAC}}$  (max) can be met,  $t_{\text{RAD}}$  (max) is specified as a reference point only; if  $t_{\text{RAD}}$  is greater than the specified  $t_{\text{RAD}}$  (max) limit, then access time is controlled exclusively by  $t_{\text{AA}}$ .
  - Either  $t_{\text{OED}}$  or  $t_{\text{CDD}}$  must be satisfied.
  - Either  $t_{\text{DZO}}$  or  $t_{\text{DZC}}$  must be satisfied.
  - $V_{\text{IH}}$  (min) and  $V_{\text{IL}}$  (max) are reference levels for measuring timing of input signals. Also, transition times are measured between  $V_{\text{IH}}$  (min) and  $V_{\text{IL}}$  (max).
  - Assumes that  $t_{\text{RCD}} \leq t_{\text{RCD}}$  (max) and  $t_{\text{RAD}} \leq t_{\text{RAD}}$  (max). If  $t_{\text{RCD}}$  or  $t_{\text{RAD}}$  is greater than the maximum recommended value shown in this table,  $t_{\text{RAC}}$  exceeds the value shown.
  - Measured with a load circuit equivalent to 1 TTL loads and  $100 \text{ pF}$ . ( $V_{\text{OH}} = 2.0 \text{ V}$ ,  $V_{\text{OL}} = 0.8 \text{ V}$ )
  - Assumes that  $t_{\text{RCD}} \geq t_{\text{RCD}}$  (max) and  $t_{\text{RAD}} \leq t_{\text{RAD}}$  (max).
  - Assumes that  $t_{\text{RCD}} \leq t_{\text{RCD}}$  (max) and  $t_{\text{RAD}} \geq t_{\text{RAD}}$  (max).
  - Either  $t_{\text{RCH}}$  or  $t_{\text{RRH}}$  must be satisfied for a read cycles.
  - $t_{\text{OFF}}$  (max) and  $t_{\text{OEZ}}$  (max) define the time at which the outputs achieve the open circuit condition and are not referred to output voltage levels.
  - $t_{\text{WCS}}$ ,  $t_{\text{RWD}}$ ,  $t_{\text{CWD}}$ ,  $t_{\text{AWD}}$  and  $t_{\text{CPW}}$  are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only; if  $t_{\text{WCS}} \geq t_{\text{WCS}}$  (min), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if  $t_{\text{RWD}} \geq t_{\text{RWD}}$  (min),  $t_{\text{CWD}} \geq t_{\text{CWD}}$  (min), and  $t_{\text{AWD}} \geq t_{\text{AWD}}$  (min), or  $t_{\text{CWD}} \geq t_{\text{CWD}}$  (min),  $t_{\text{AWD}} \geq t_{\text{AWD}}$  (min) and  $t_{\text{CPW}} \geq t_{\text{CPW}}$  (min), the cycle is a read-modify-write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
  - These parameters are referred to  $\overline{\text{CAS}}$  leading edge in early write cycles and to  $\overline{\text{WE}}$  leading edge in delayed write or read-modify-write cycles.
  - $t_{\text{RASP}}$  defines  $\overline{\text{RAS}}$  pulse width in Fast page mode cycles.
  - Access time is determined by the longest among  $t_{\text{AA}}$ ,  $t_{\text{CAC}}$  and  $t_{\text{CPA}}$ .
  - In delayed write or read-modify-write cycles,  $\overline{\text{OE}}$  must disable output buffer prior to applying data to the device.
  - Please do not use  $t_{\text{RASS}}$  timing,  $10 \mu\text{s} \leq t_{\text{RASS}} \leq 100 \mu\text{s}$ . During this period, the device is in transition state from normal operation mode to self refresh mode. If  $t_{\text{RASS}} \geq 100 \mu\text{s}$ , then  $\overline{\text{RAS}}$  precharge time should use  $t_{\text{RPS}}$  instead of  $t_{\text{RP}}$ .
  - If you use  $\overline{\text{RAS}}$  only refresh or CBR burst refresh mode in normal read/write cycles, 2048 cycles of distributed CBR refresh with 15.6 Ms interval should be executed within 32 ms immediately after exiting from and before entering into the self refresh mode.

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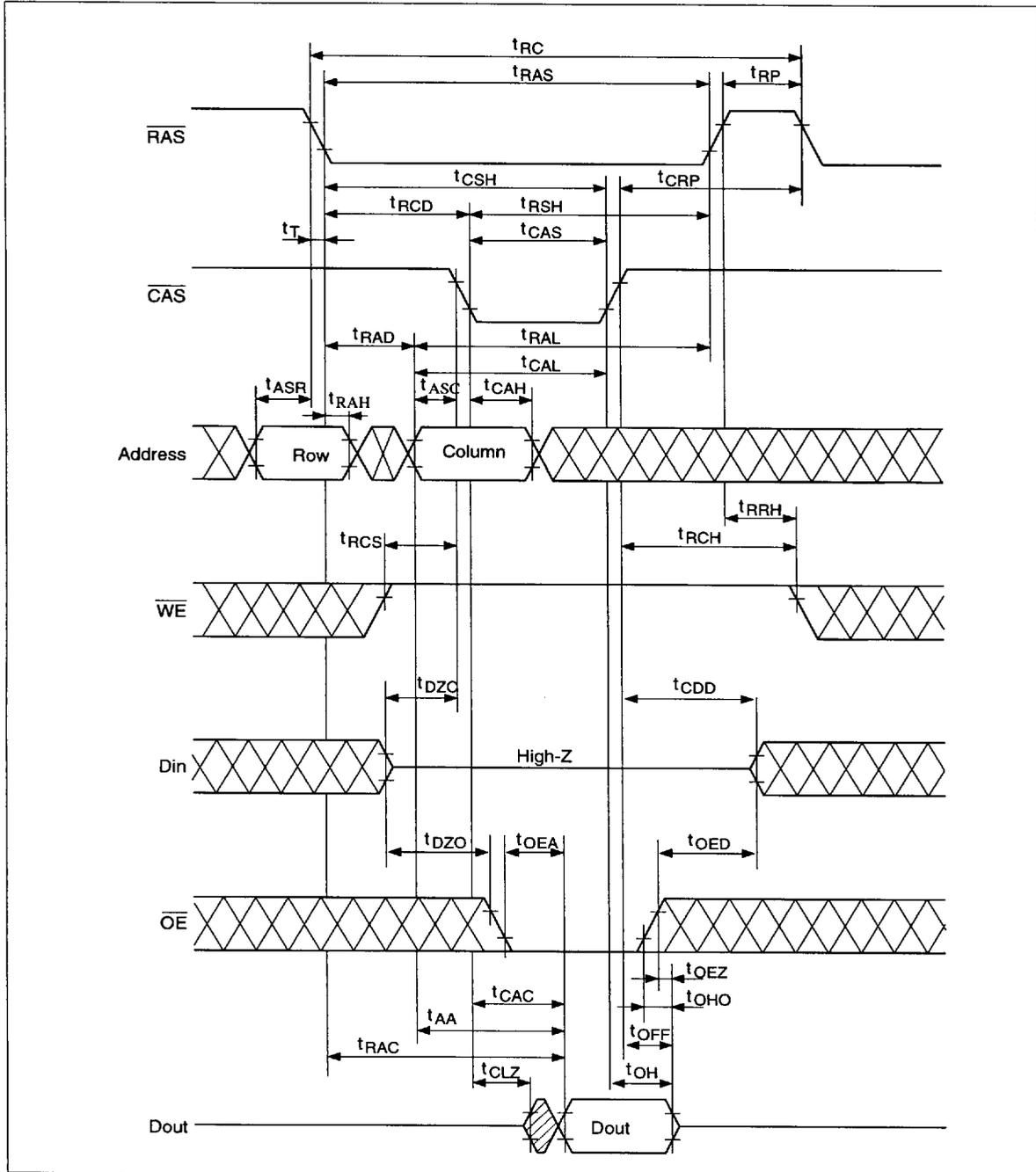
## HM51W17800B Series

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21. If you use distributed CBR refresh mode with 15.6  $\mu$ s interval in normal read/write cycle, CBR refresh should be executed within 15.6  $\mu$ s immediately after exiting from and before entering into self refresh mode.
22. Repetitive self refresh mode without refreshing all memory is not allowed. Once you exit from self refresh mode, all memory cells need to be refreshed before re-entering the self refresh mode again.
23. XXX: H or L (H:  $V_{IH}(\min) \leq V_{IN} \leq V_{IH}(\max)$ , L:  $V_{IL}(\min) \leq V_{IN} \leq V_{IL}(\max)$ )  
///: Invalid Dout  
When the address, clock and input pins are not described on timing waveforms, their pins must be applied  $V_{IH}$  or  $V_{IL}$ .

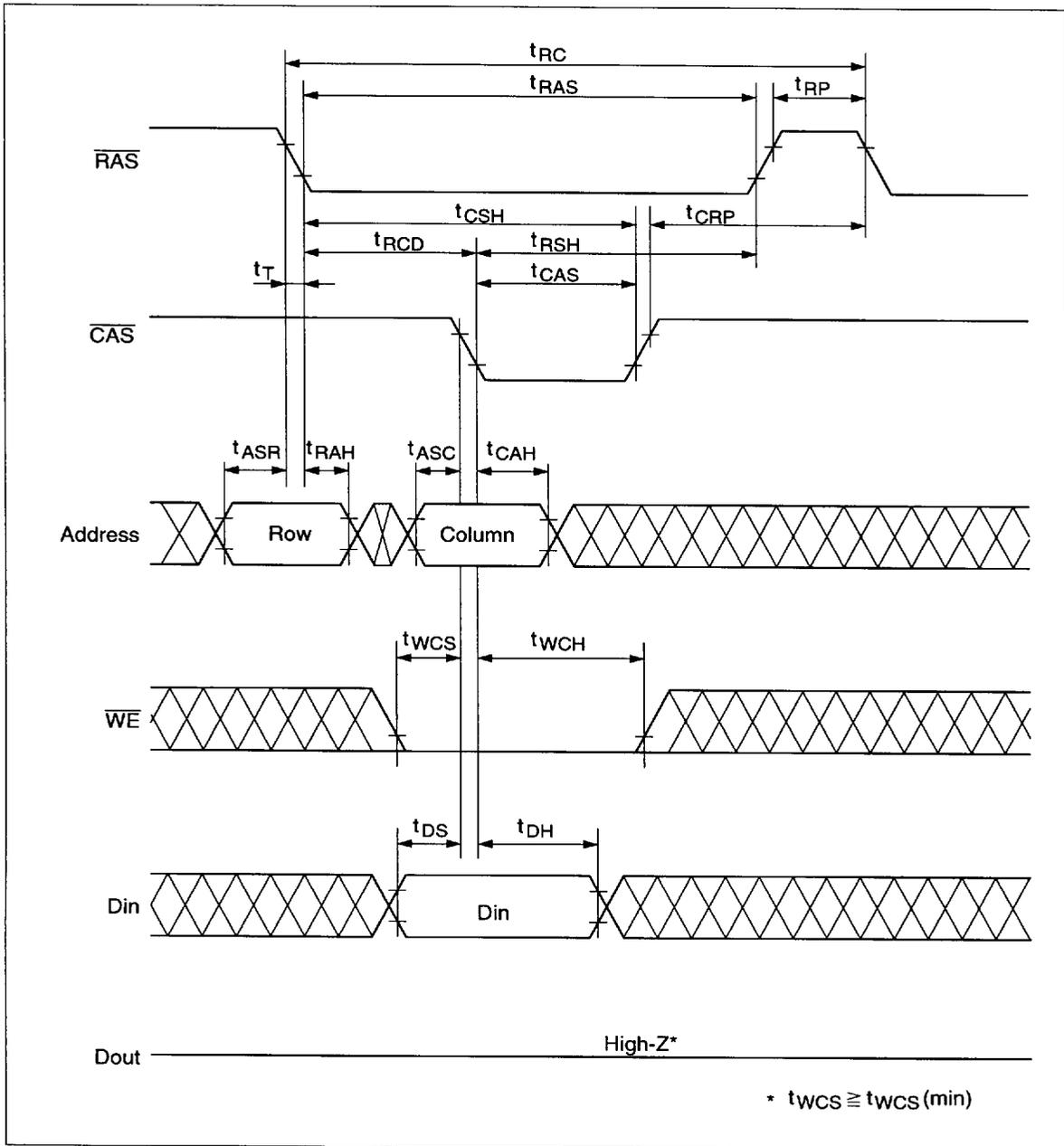
Timing Waveforms\*23

Read Cycle



Early Write Cycle

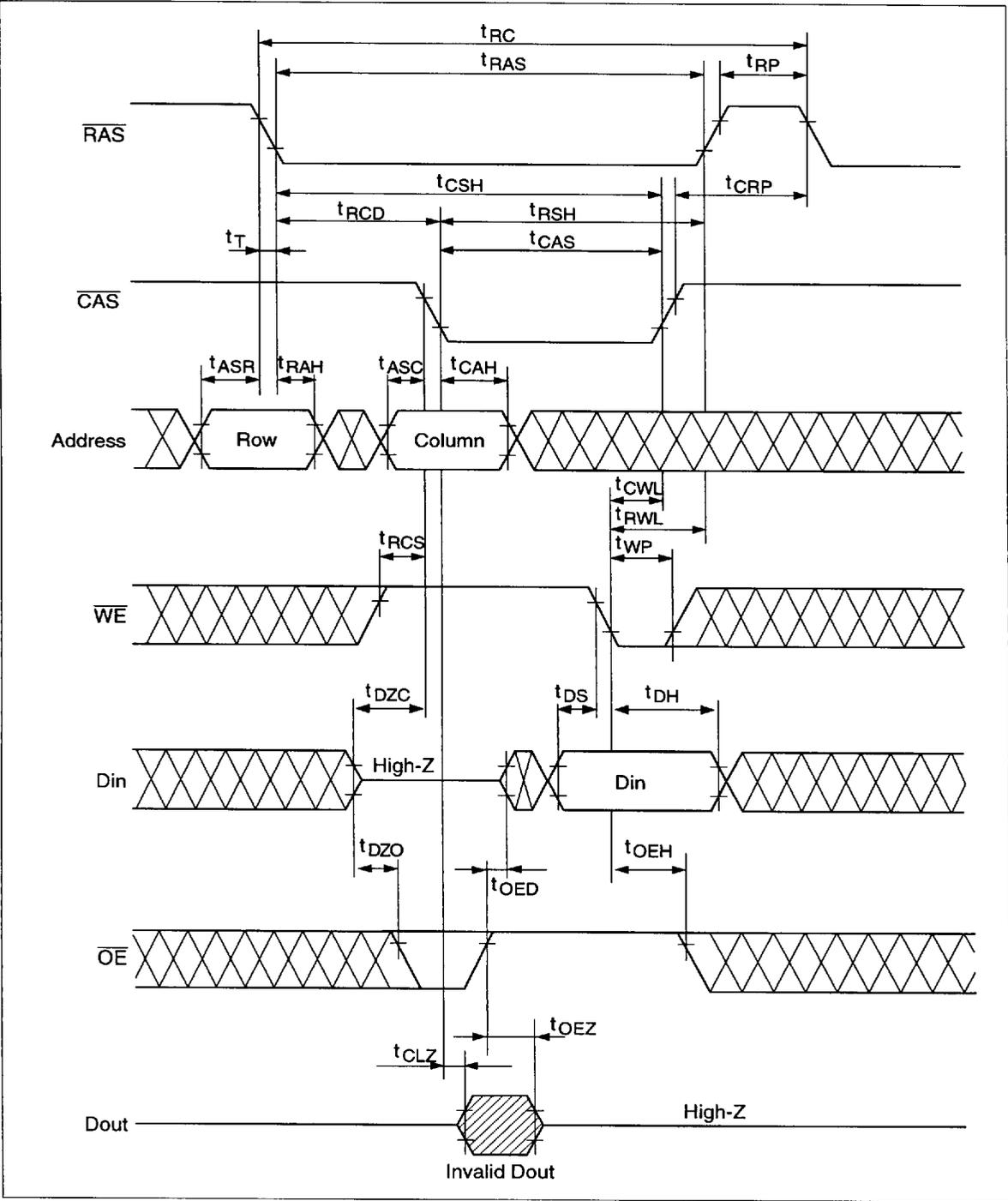
# HM51W17800B Series



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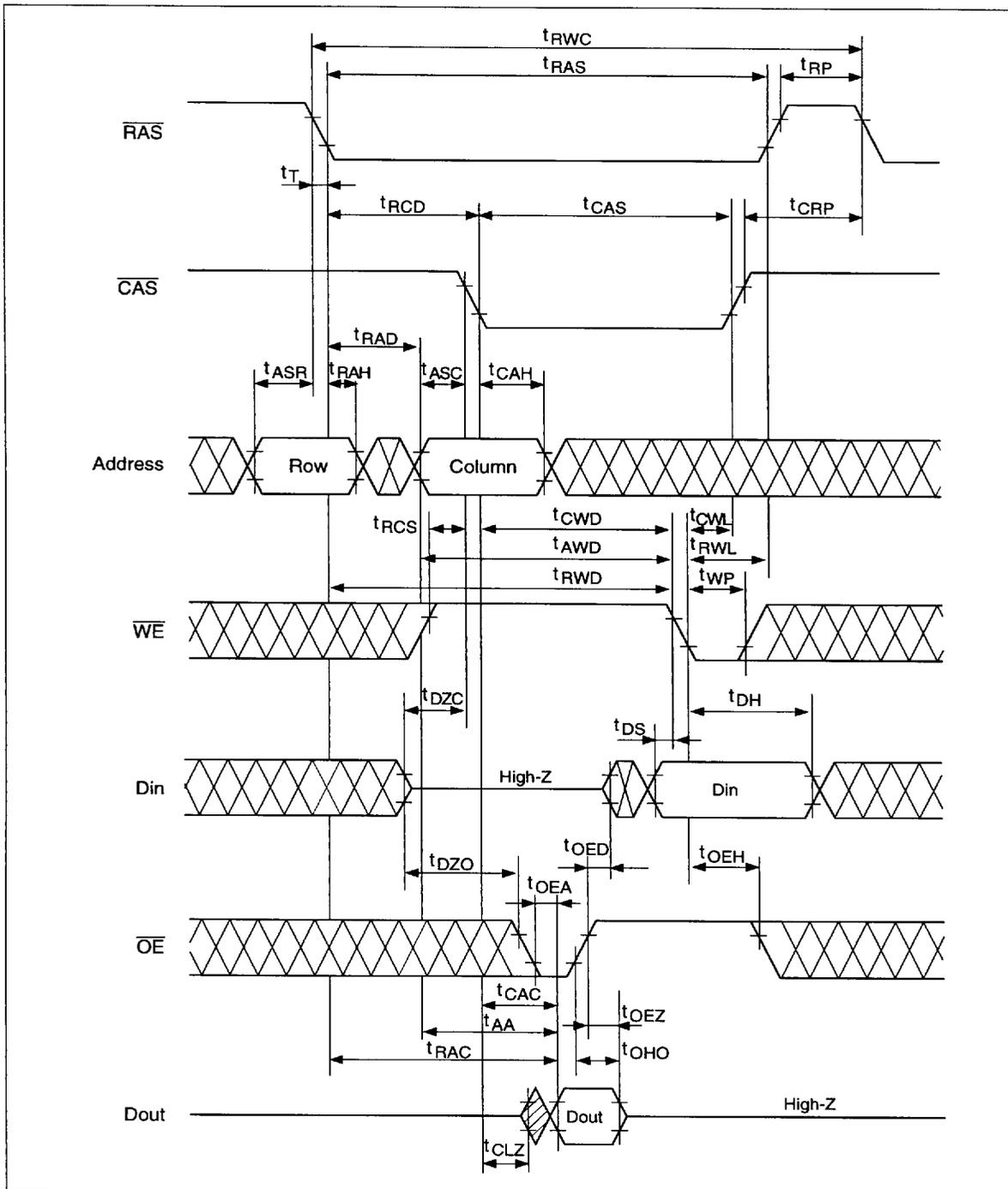
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Delayed Write Cycle<sup>\*18</sup>



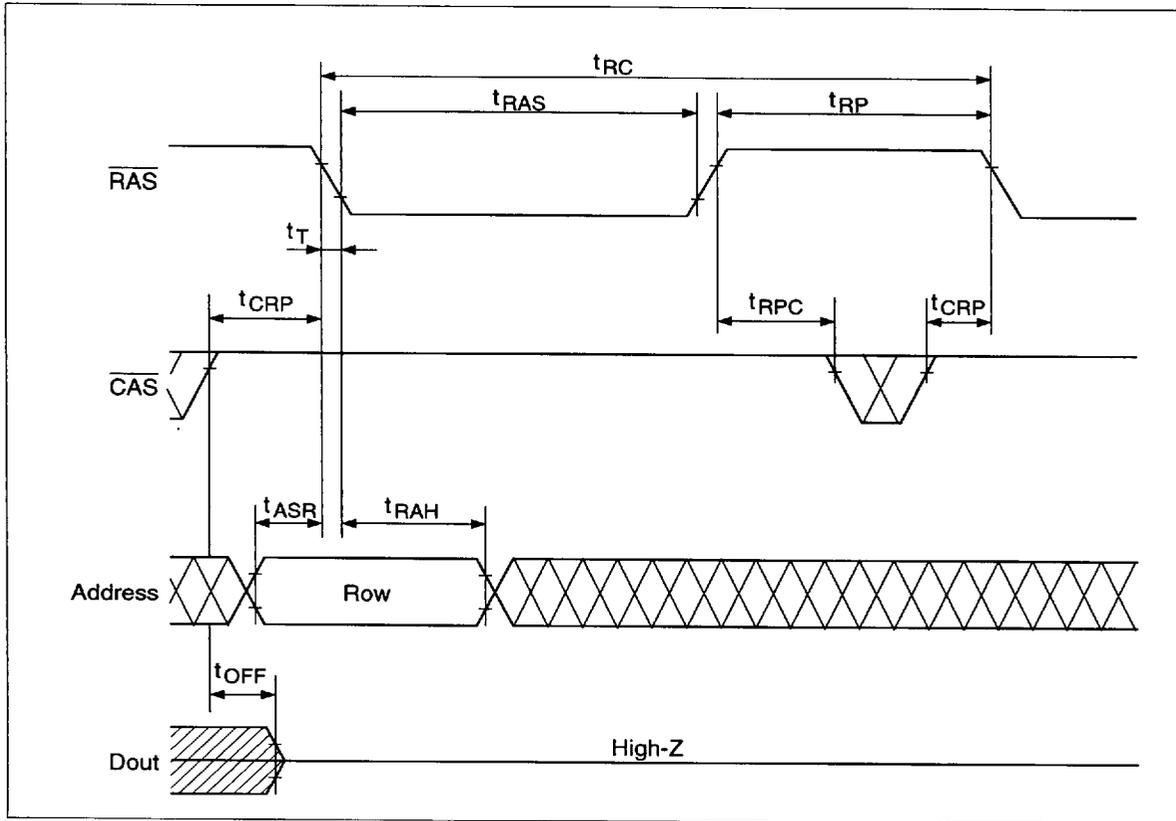
Read-Modify-Write Cycle<sup>\*18</sup>

# HM51W17800B Series



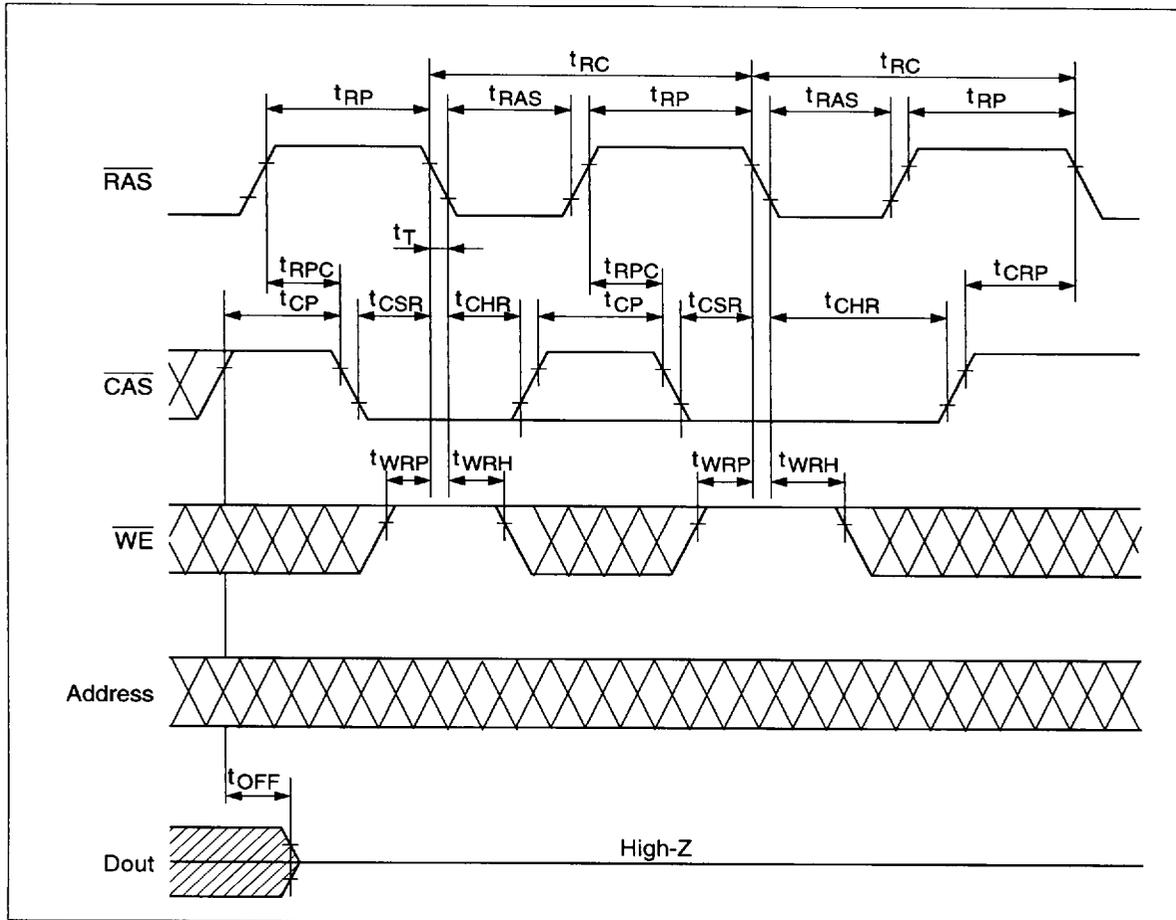
4496203 0027038 757

RAS-Only Refresh Cycle



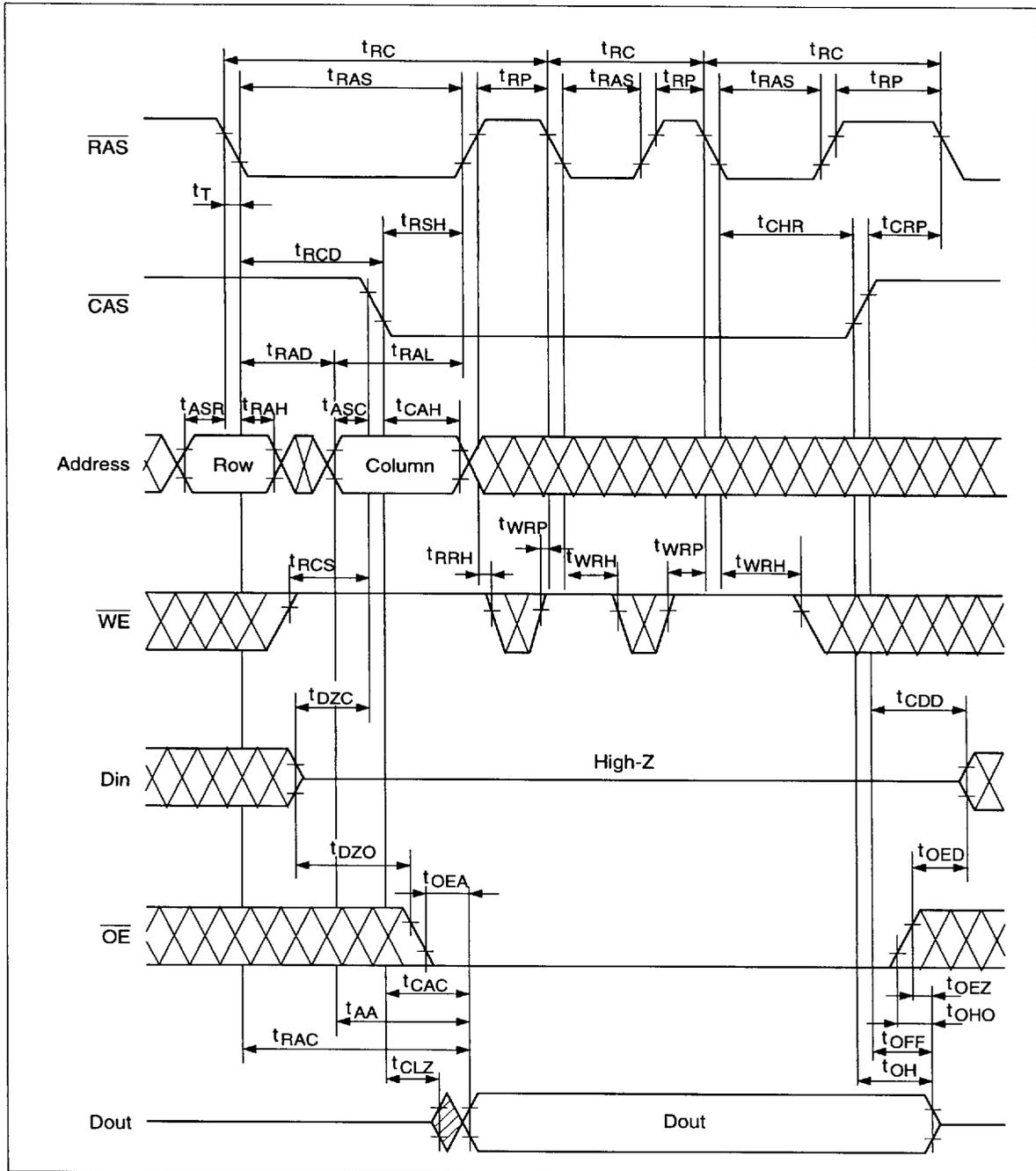
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## CAS-Before-RAS Refresh Cycle



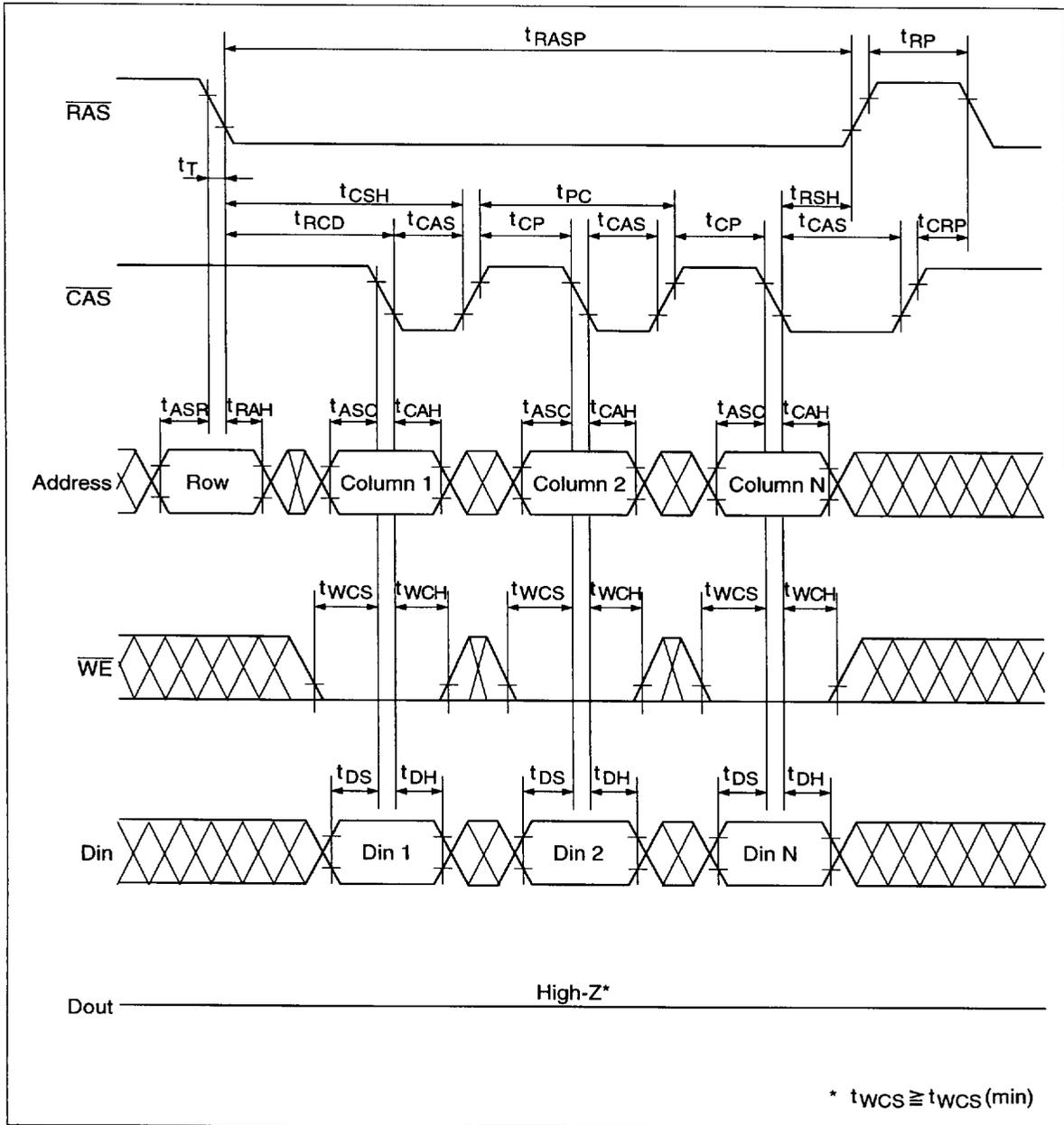
4496203 0027040 305

Hidden Refresh Cycle





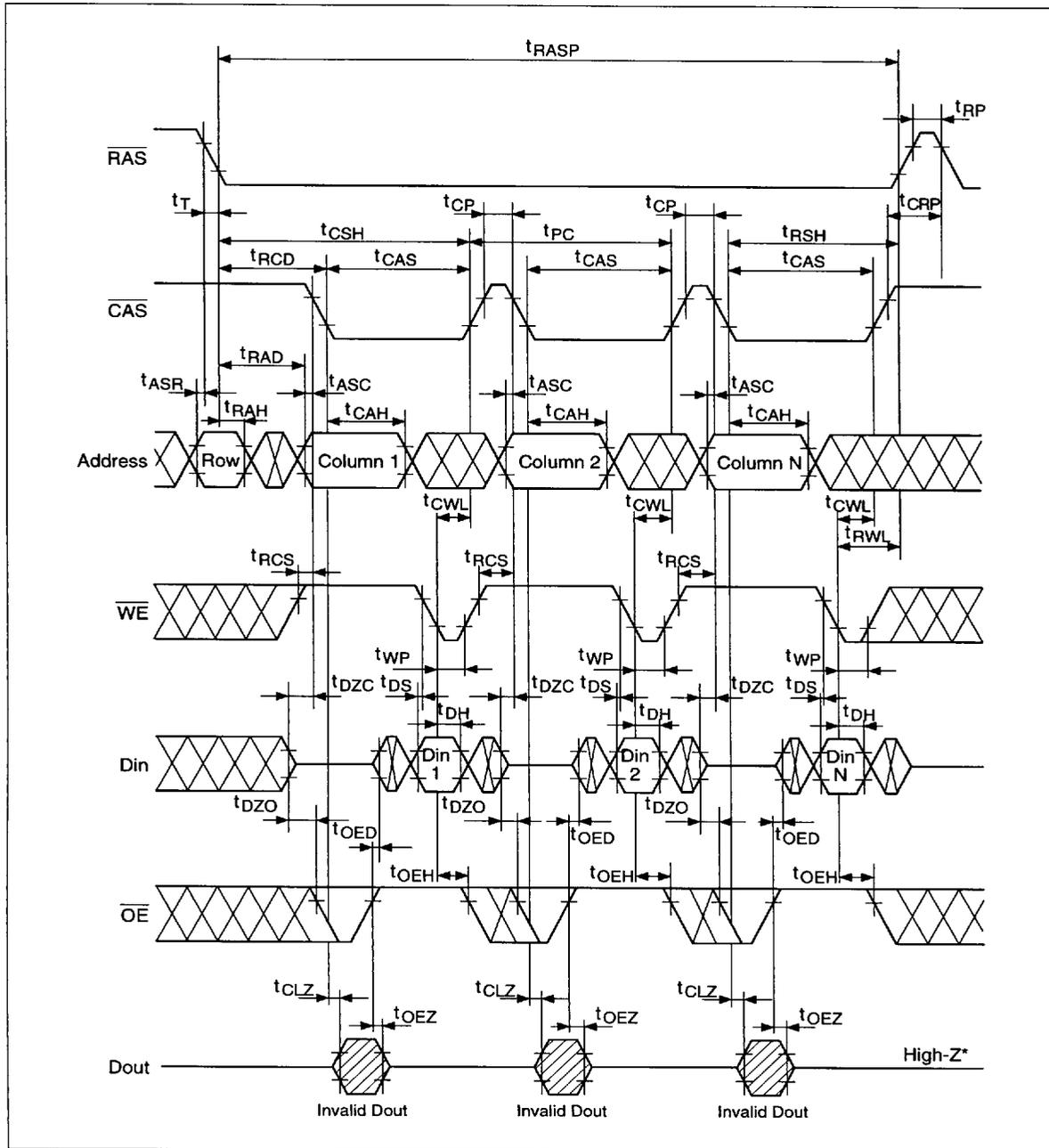
# HM51W17800B Series



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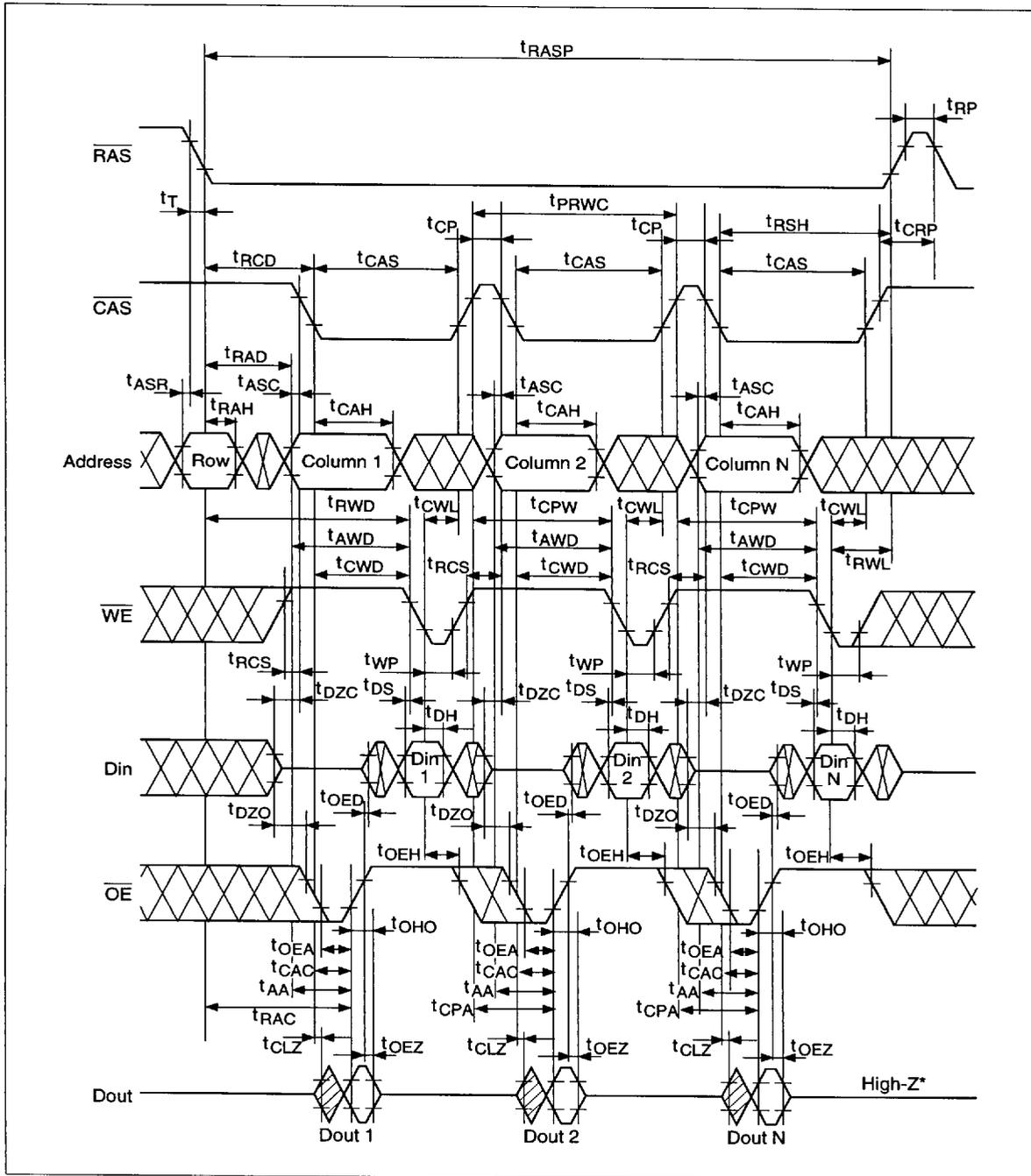
# HM51W17800B Series

## Fast Page Mode Delayed Write Cycle<sup>18</sup>



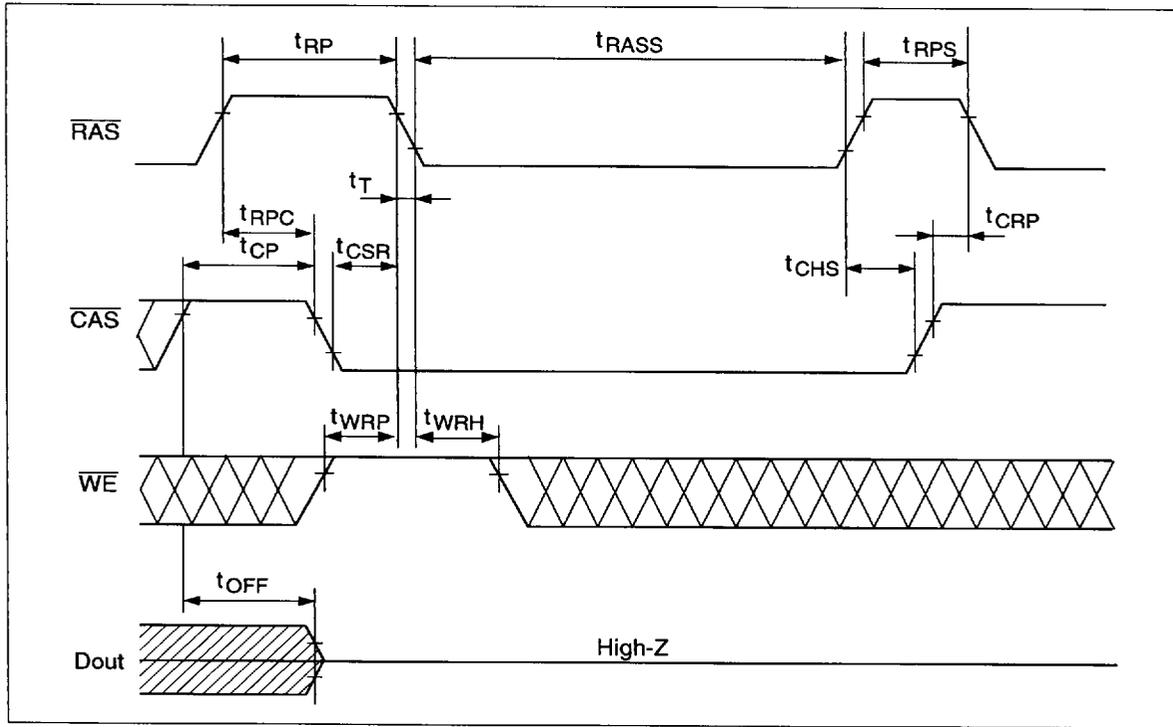
4496203 0027044 T50

Fast Page Mode Read-Modify-Write Cycle\*18



# HM51W17800B Series

Self Refresh Cycle (L-version)\* 19, 20, 21, 22



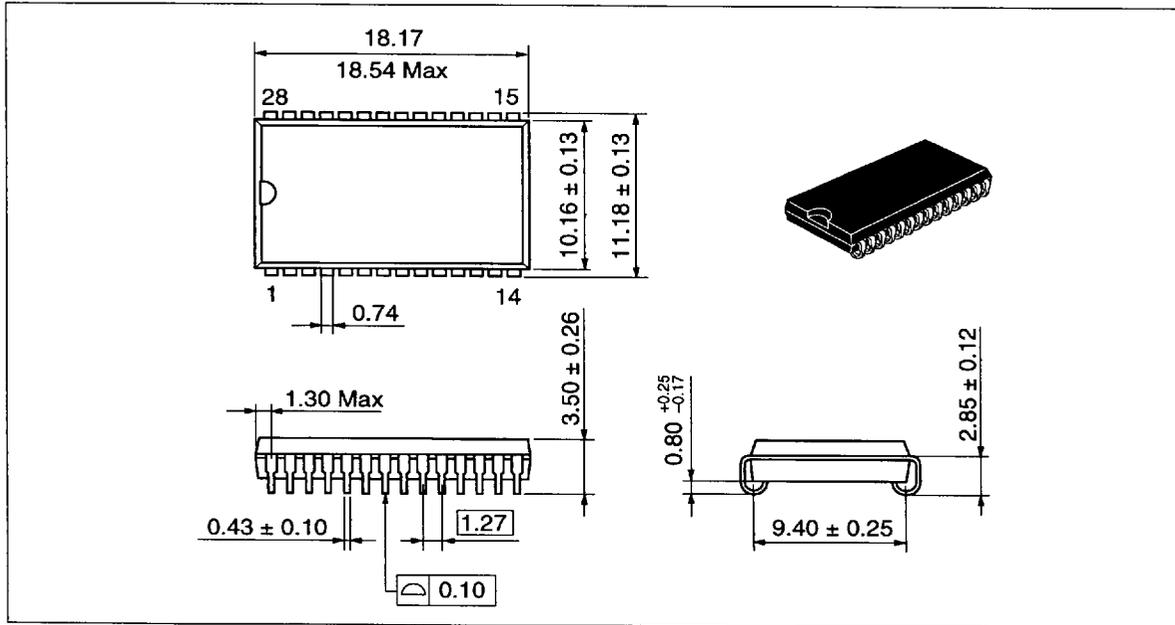
4496203 0027046 823

# HM51W17800B Series

## Package Dimensions

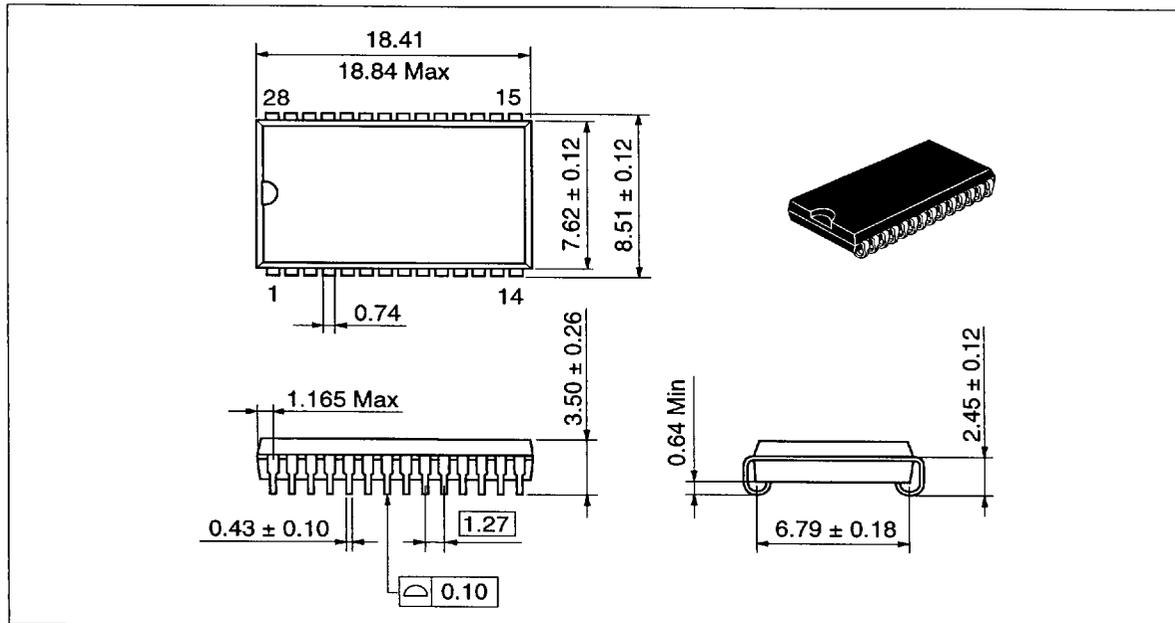
HM51W17800BJ/BLJ Series (CP-28DA)

Unit: mm



HM51W17800BS/BLS Series (CP-28DNA)

Unit: mm



4496203 0027047 76T

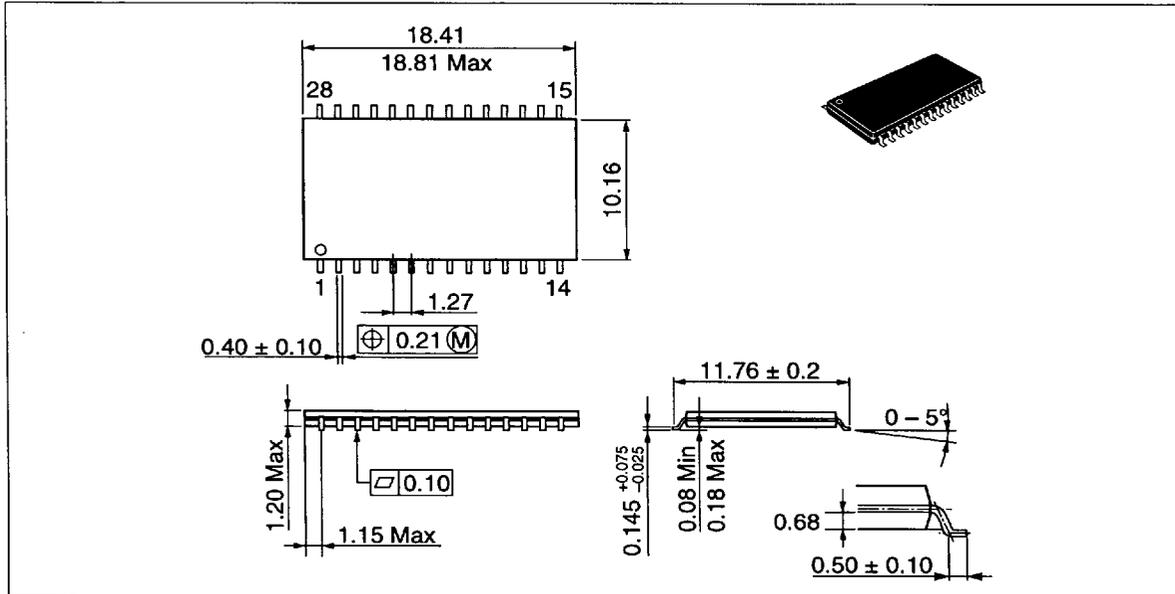


# HM51W17800B Series

## Package Dimensions (cont)

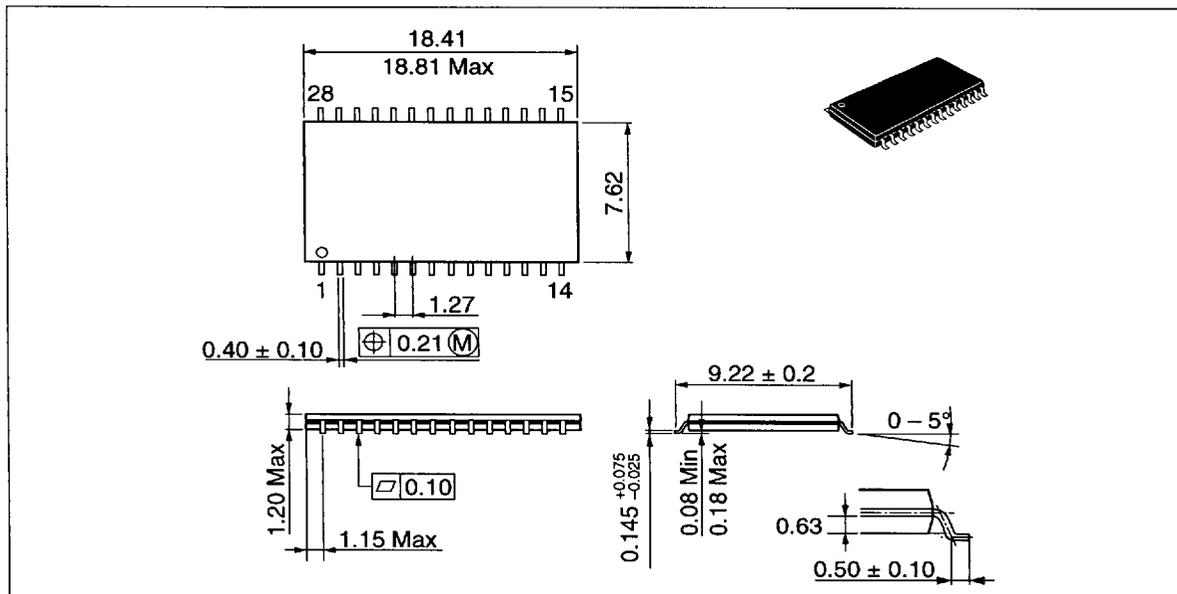
HM51W17800BTT/BLTT Series (TTP-28DA)

Unit: mm



HM51W17800BTS/BLTS Series (TTP-28DB)

Unit: mm



4496203 0027048 6T6

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# HITACHI

## Hitachi, Ltd.

Semiconductor & IC Div.  
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan  
Tel: Tokyo (03) 3270-2111  
Fax: (03) 3270-5109

### For further information write to:

Hitachi America, Ltd.  
Semiconductor & IC Div.  
2000 Sierra Point Parkway  
Brisbane, CA. 94005-1835  
U S A  
Tel: 415-589-8300  
Fax: 415-583-4207

Hitachi Europe GmbH  
Electronic Components Group  
Continental Europe  
Domacher Straße 3  
D-85622 Feldkirchen  
München  
Tel: 089-9 91 80-0  
Fax: 089-9 29 30 00

Hitachi Europe Ltd.  
Electronic Components Div.  
Northern Europe Headquarters  
Whitebrook Park  
Lower Cookham Road  
Maidenhead  
Berkshire SL6 8YA  
United Kingdom  
Tel: 0628-585000  
Fax: 0628-778322

Hitachi Asia Pte. Ltd.  
16 Collyer Quay #20-00  
Hitachi Tower  
Singapore 0104  
Tel: 535-2100  
Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd.  
Unit 706, North Tower,  
World Finance Centre,  
Harbour City, Canton Road  
Tsim Sha Tsui, Kowloon  
Hong Kong  
Tel: 27359218  
Fax: 27306071

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## HM51W17800B Series

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### Revision Record

Rev.	Date	Contents of Modification	Drawn by	Approved by
0.0	Jul. 13, 1994	Initial issue	Y. Takahashi	K. Hayakawa
0.1	Nov. 11, 1994	DC characteristics Addition of note 4	Y. Takahashi	K. Hayakawa
0.2	Dec. 2, 1994	Change of Block Diagram	Y. Takahashi	K. Hayakawa
1.0	Jun. 29, 1995	DC characteristics $I_{CC2}$ max: 100/100/100 $\mu$ A to 150/150/150 $\mu$ A $I_{CC11}$ max: 200/200/200 $\mu$ A to 250/250/250 $\mu$ A $\overline{\text{RAS}}$ -only refresh cycle $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh cycle Self refresh cycle	K. Goto	K. Hayakawa
2.0	Sep. 20, 1995	Power dissipation Standby mode (L-version): 0.36 mW max to 0.54 mW max	Y. Takahashi	K. Hayakawa
3.0	Jul. 5, 1996	Addition of HM51W17800BTS/BLTS Series(TTP-28DB) Addition of HM51W17800BS/BLS Series(CP-28DNA) AC characteristics Change of notes 18 and 23 Timing waveforms Change of early write cycle and EDO page mode early write cycle Deletion of note: $t_{OEH} \geq t_{CWE}$		

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■ 4496203 0027050 254 ■